



Atty. Dkt. No. 035905-0164

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: S. Brad HERNER et al.
Title: LOW-TEMPERATURE, LOW-RESISTIVITY HEAVILY DOPED P-TYPE POLYSILICON DEPOSITION
Appl. No.: 10/769,047
Filing Date: 1/30/2004
Examiner: Chen, Bret P.
Art Unit: 1762
Confirmation No.: 7037

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This communication is responsive to the Notice of Non-Compliant Amendment mailed on July 10, 2007, concerning the above-referenced patent application. Applicants resubmit herewith the updated "Amendments to the Claims" section of the Amendment filed on April 26, 2007, in compliance with 37 CFR § 1.121. Since this paper is filed within the one-month shortened statutory period, Applicants consider this paper timely filed.

Respectfully submitted,

Date 7/8/07

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